## **DISCRETE SEMICONDUCTORS**

## DATA SHEET

# **BFS520**NPN 9 GHz wideband transistor

**Product specification** 

September 1995



## NPN 9 GHz wideband transistor

**BFS520** 

#### **FEATURES**

- High power gain
- Low noise figure
- High transition frequency
- Gold metallization ensures excellent reliability
- SOT323 envelope.

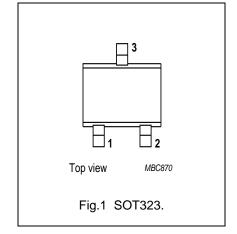
## **DESCRIPTION**

NPN transistor in a plastic SOT323 envelope.

It is intended for wideband applications such as satellite TV tuners, cellular phones, cordless phones, pagers etc., with signal frequencies up to 2 GHz.

## **PINNING**

PIN	DESCRIPTION	
Code: N2		
1	base	
2	emitter	
3	collector	



## **QUICK REFERENCE DATA**

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V <sub>CBO</sub>	collector-base voltage	open emitter	_	_	20	٧
V <sub>CES</sub>	collector-emitter voltage	R <sub>BE</sub> = 0	-	-	15	V
I <sub>C</sub>	DC collector current		-	-	70	mA
P <sub>tot</sub>	total power dissipation	up to $T_s = 118 ^{\circ}\text{C}$ ; note 1	-	-	300	mW
h <sub>FE</sub>	DC current gain	$I_C = 20 \text{ mA}; V_{CE} = 6 \text{ V}; T_j = 25 ^{\circ}\text{C}$	60	120	250	
f <sub>T</sub>	transition frequency	$I_C = 20 \text{ mA}; V_{CE} = 6 \text{ V}; f = 1 \text{ GHz};$ $T_{amb} = 25 \text{ °C}$	_	9	_	GHz
G <sub>UM</sub>	maximum unilateral power gain	$I_c = 20 \text{ mA}; V_{CE} = 6 \text{ V}; f = 900 \text{ MHz}; $ $T_{amb} = 25 \text{ °C}$	_	15	_	dB
F	noise figure	$I_c = 5 \text{ mA}; V_{CE} = 6 \text{ V}; f = 900 \text{ MHz};$ $T_{amb} = 25 \text{ °C}$	_	1.1	1.6	dB

## **LIMITING VALUES**

In accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>CBO</sub>	collector-base voltage	open emitter	_	20	V
V <sub>CES</sub>	collector-emitter voltage	R <sub>BE</sub> = 0	_	15	V
V <sub>EBO</sub>	emitter-base voltage	open collector	_	2.5	V
Ic	DC collector current		_	70	mA
P <sub>tot</sub>	total power dissipation	up to T <sub>s</sub> = 118 °C; note 1	_	300	mW
T <sub>stg</sub>	storage temperature		-65	150	°C
Tj	junction temperature		_	175	°C

## Note

1.  $T_s$  is the temperature at the soldering point of the collector tab.

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#### THERMAL RESISTANCE

SYMBOL	PARAMETER	CONDITIONS	THERMAL RESISTANCE
R <sub>th j-s</sub>	thermal resistance from junction to soldering point	up to $T_s = 118$ °C; note 1	190 K/W

#### Note

1.  $T_{\mbox{\scriptsize S}}$  is the temperature at the soldering point of the collector tab.

#### **CHARACTERISTICS**

 $T_j = 25$  °C, unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I <sub>CBO</sub>	collector cut-off current	I <sub>E</sub> = 0; V <sub>CE</sub> = 6 V	_	_	50	nA
h <sub>FE</sub>	DC current gain	I <sub>C</sub> = 20mA; V <sub>CE</sub> = 6 V	60	120	250	
C <sub>e</sub>	emitter capacitance	$I_C = I_C = 0$ ; $V_{EB} = 0.5 \text{ V}$ ; $f = 1 \text{ MHz}$	-	1	_	pF
C <sub>c</sub>	collector capacitance	$I_E = i_e = 0$ ; $V_{CB} = 6 \text{ V}$ ; $f = 1 \text{ MHz}$	-	0.5	_	pF
C <sub>re</sub>	feedback capacitance	I <sub>C</sub> = 0; V <sub>CB</sub> = 6 V; f = 1 MHz	_	0.4	_	pF
f <sub>T</sub>	transition frequency	$I_C = 20 \text{ mA}; V_{CE} = 6 \text{ V}; f = 1 \text{ GHz};$ $T_{amb} = 25 ^{\circ}\text{C}$	_	9	_	GHz
G <sub>UM</sub>	maximum unilateral power gain (note 1)	$I_C = 20 \text{ mA}; V_{CE} = 6 \text{ V}; f = 900 \text{ MHz};$ $T_{amb} = 25 ^{\circ}\text{C}$	_	15	_	dB
		$I_C = 20 \text{ mA}; V_{CE} = 6 \text{ V}; f = 2 \text{ GHz};$ $T_{amb} = 25 ^{\circ}\text{C}$	_	9	_	dB
S <sub>21</sub>   <sup>2</sup>	insertion power gain	$I_C = 20 \text{ mA}; V_{CE} = 6 \text{ V}; f = 900 \text{ MHz};$ $T_{amb} = 25 ^{\circ}\text{C}$	13	14	-	dB
F	noise figure	$\Gamma_{\rm S} = \Gamma_{\rm opt}$ ; $I_{\rm C} = 5$ mA; $V_{\rm CE} = 6$ V; $f = 900$ MHz; $T_{\rm amb} = 25$ °C	_	1.1	1.6	dB
		$\Gamma_{\text{S}} = \Gamma_{\text{opt}}$ ; $I_{\text{C}} = 20$ mA; $V_{\text{CE}} = 6$ V; $f = 900$ MHz; $T_{\text{amb}} = 25$ °C	_	1.6	2.1	dB
		$\Gamma_{\rm S} = \Gamma_{\rm opt}$ ; $I_{\rm C} = 5$ mA; $V_{\rm CE} = 6$ V; $f = 2$ GHz; $T_{\rm amb} = 25$ °C	_	1.9	_	dB
P <sub>L1</sub>	output power at 1 dB gain compression	$I_c$ = 20 mA; $V_{CE}$ = 6 V; $R_L$ = 50 Ω; $f$ = 900 MHz; $T_{amb}$ = 25 °C	_	17	_	dBm
ITO	third order intercept point	note 2	_	26	_	dBm

## **Notes**

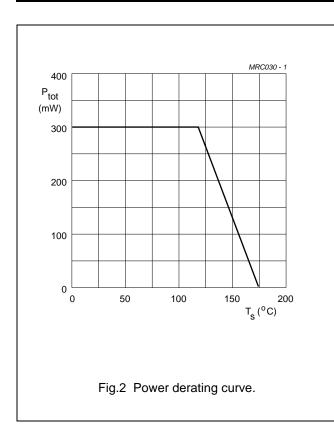
1.  $\,\,G_{UM}$  is the maximum unilateral power gain, assuming  $S_{12}$  is zero and

$$G_{UM} = 10 \log \frac{|S_{21}|^2}{(1 - |S_{11}|^2)(1 - |S_{22}|^2)} dB.$$

 $\begin{array}{ll} \text{2.} & \text{I}_{\text{C}} = 20 \text{ mA; V}_{\text{CE}} = 6 \text{ V; R}_{\text{L}} = 50 \; \Omega; \, \text{f} = 900 \text{ MHz; T}_{\text{amb}} = 25 \; ^{\circ}\text{C;} \\ & \text{f}_{\text{p}} = 900 \text{ MHz; f}_{\text{q}} = 902 \text{ MHz; measured at f}_{(2p-q)} = 898 \text{ MHz and at f}_{(2q-p)} = 904 \text{ MHz.} \\ \end{array}$ 

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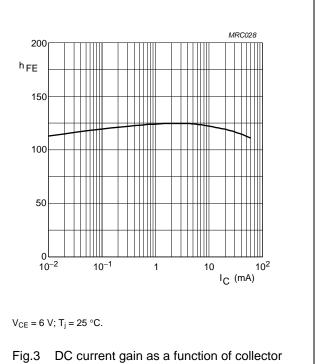
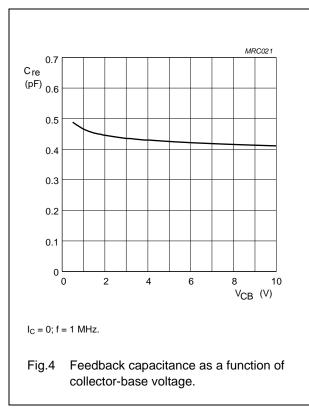
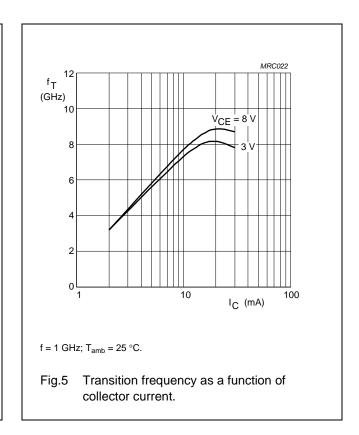


Fig.3 DC current gain as a function of collector current.





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In Figs 6 to 9,  $G_{UM}$  = maximum unilateral power gain; MSG = maximum stable gain;  $G_{max}$  = maximum available gain.

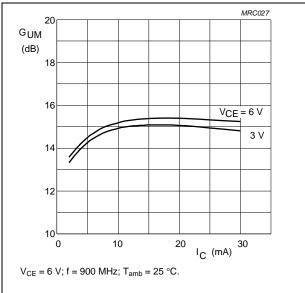
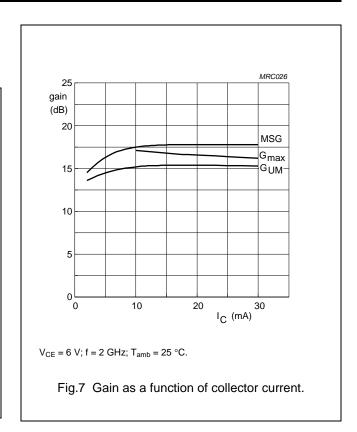
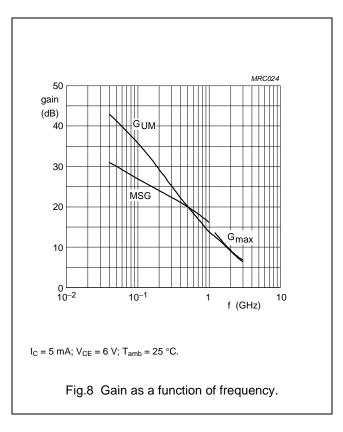
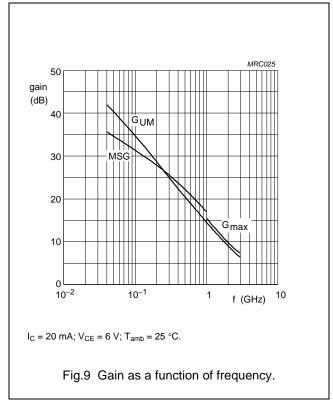


Fig.6 Maximum unilateral power gain as a function of collector current.







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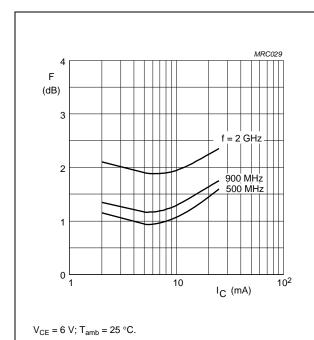


Fig.10 Minimum noise figure as a function of collector current.

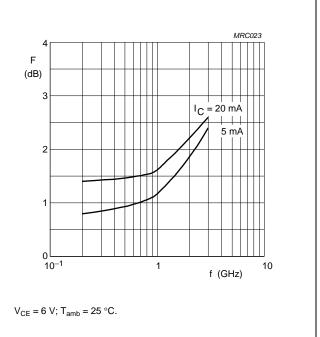
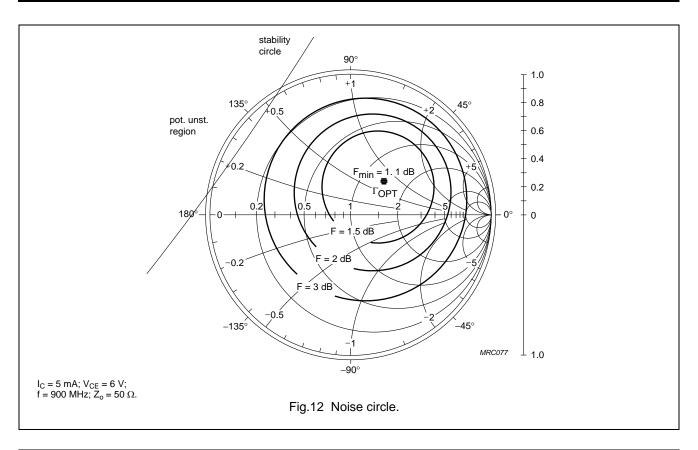
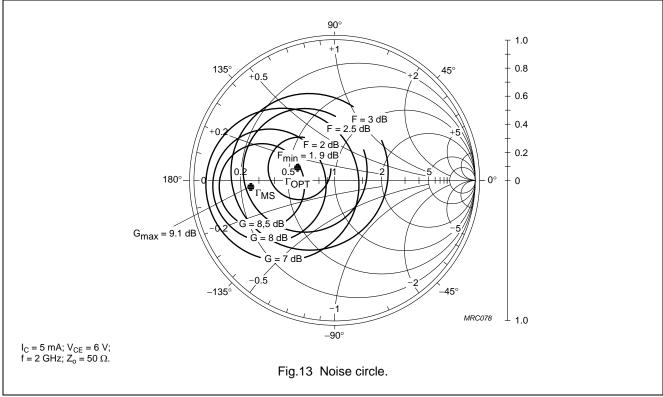


Fig.11 Minimum noise figure as a function of frequency.

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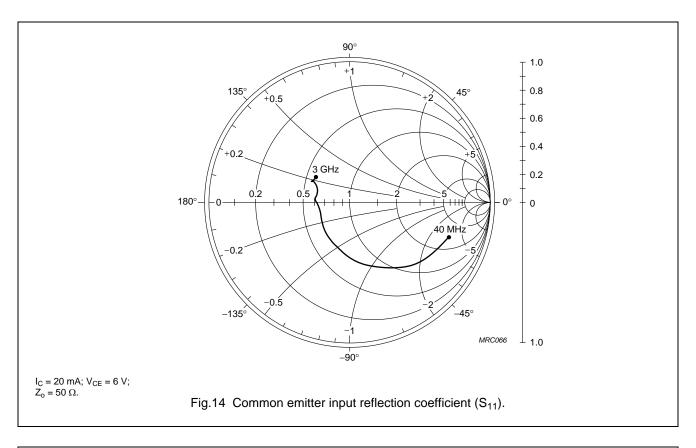
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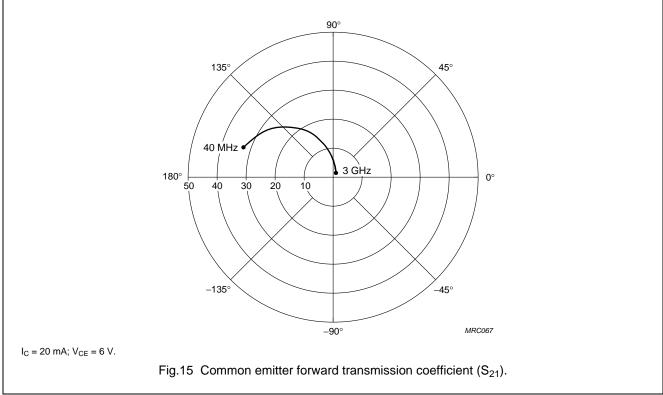




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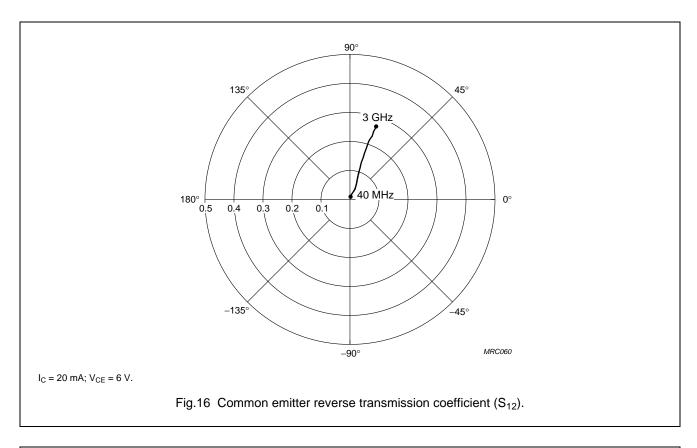
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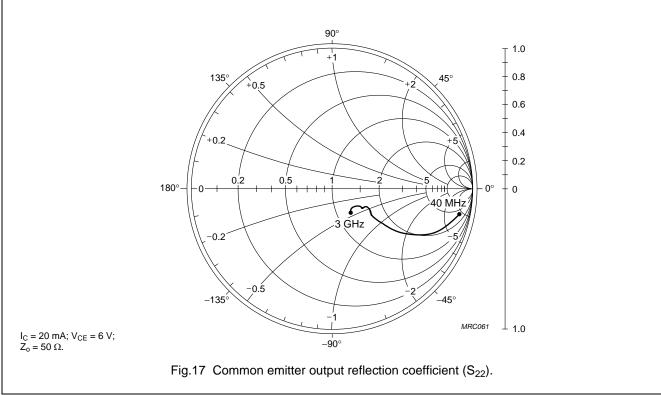




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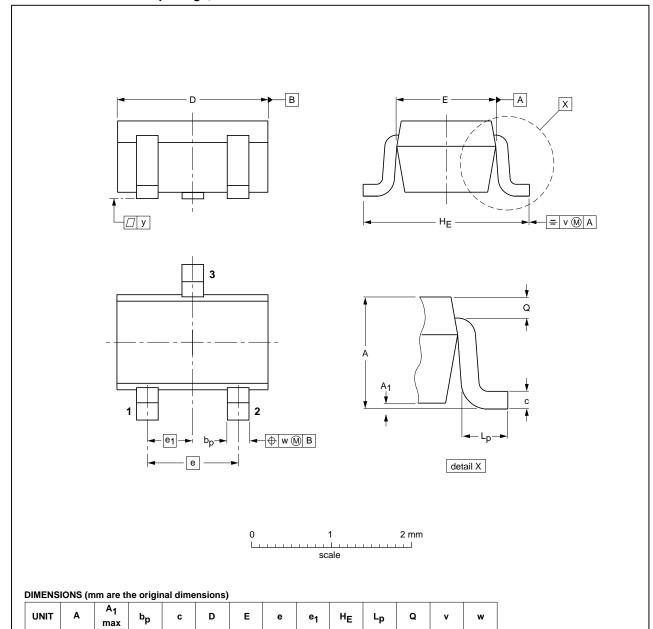
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## **PACKAGE OUTLINE**

Plastic surface-mounted package; 3 leads

**SOT323** 



OUTLINE	REFERENCES		EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT323			SC-70			<del>04-11-04</del> 06-03-16

2.2 2.0

0.65

0.45

0.23

0.2

1.1 0.8

mm

0.1

0.4 0.3

0.25

0.10

2.2

1.35

1.3

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Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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